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Case Docket No. <u>001066</u>

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8-31-00

To the Director of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Shinsuke NAKAJYO, Masanori ONODERA and Masamitsu IKUMO

Additional name(s) of conveying party(ies) attached? NO

2. Name and address of receiving party(ies):

Name: FUJITSU LIMITED

04/153,334

Street Address: 1-1, Kamikodanaka 4-chome, Nakahara-ku

Kawasaki-shi, Kanagawa 211-8588, JAPAN

Additional name(s) & address(es) attached? NO

3. Nature of conveyance: Assignment

Execution Date: August 25, 2000

4. Title: METHOD FOR FIXING A SEMICONDUCTOR DEVICE HAVING STUD BUMPS TO A SUBSTRATE BY AN ELECTRICALLY NON-**CONDUCTIVE ADHESIVE**

5. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: August 25, 2000

A. Patent Application No.(s) B. Patent No.(s)

Additional numbers attached? NO

39/12/2000 PALLEN

PATENT

REEL: 011069 FRAME: 0405

6. Name and address of party to whom correspondence concerning document should be mailed: Name: Armstrong, Westerman, Hattori, McLeland & Naughton **Suite 1000** 1725 K Street, N.W. Washington, D.C. 20006 7. Total number of applications and patents involved: $\underline{1}$ XX Check enclosed 9. Deposit Account No.: **01-2340** 10. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Date August 31, 2000 Donald W. Hanson

Reg. No.: 27,133

Total number of pages including cover sheet: 3

DWH/ll

PATENT REEL: 011069 FRAME: 0406

Armstrong, Westerman, Hattori, McLeland & Naugl	ıton
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	U.S. ASSIC	SNMENT		
		m of One Dollar (\$1.00), and of d inventor(s) (hereinafter ASSIGNO		
(Insert ASSIGNEE's Name(s) Address(es))	FUJITSU LIMITED 1-1, Kamikodanaka 4-chome, Nakahara-ku,			
	Kawasaki-shi, Kanagawa, 211-8588 Japan			
	(hereinafter ASSIGNEE), the receip hereby sells, assigns and transfers to the invention entitled	t of which is hereby acknowledged, to ASSIGNEE the entire and exclusive	he undersigned ASSIGNOR ve right, title and interest to	
(Title of Invention)	METHOD FOR FIXING A SEMICONDUCTOR DEVICE HAVING STUD BUMPS TO A SUBSTRATE BY AN ELECTRICALLY NON-CONDUCTIVE ADHESIVE			
(*If the assignment is being filed after the filing of the application, this	for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:			
section must be	*filed on, Serial No (Armstrong, Westerman, Hattori, McLeland & Naughton is hereby authorized to insert the series			
completed)	(Armstrong, Westerman, Hattori, McLeland & Naughton is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)			
	and all Letters Patent of the United States to be obtained therefor on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.			
	The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.			
	The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.			
	IN WITNESS WHEREOF, the un	dersigned inventor(s) has (have) affixe	ed his/her/their signature(s).	
	(SIGNATURE) Museuwi Prusdera (SIGNATURE)	Shinsuke Nakajyo	August 25, 2000	
(Signatures)	(SIGNATURE)	(TYPE NAME)	(DATE)	
		Masanori Onodera	August 25, 2000	
	Masawer Trodera	(TYPE NAME)	(DATE)	
	(SIGNATORE)	Masamitsu Ikumo	August 25, 2000	
	(SIGNATURE)	(TYPE NAME)	(DATE)	
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	NO LEGALIZATION REQUIRE	D		

Rev. #2 10/92

PATENT REEL: 011069 FRAME: 0407

Docket No.